

02108/02
2002046662

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization
International Bureau



(43) International Publication Date
10 April 2003 (10.04.2003)

PCT

(10) International Publication Number
WO 03/030191 A1

(51) International Patent Classification⁷: H01F 27/29,
27/04

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Hyogo 667-0021 (JP). IWASAKI, Hitoshi [JP/JP]; 2-17,
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(21) International Application Number: PCT/JP02/03967

(22) International Filing Date: 19 April 2002 (19.04.2002)

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(25) Filing Language: English

(26) Publication Language: English

(81) Designated States (*national*): CN, SG, US.

(30) Priority Data:
2001-301751 28 September 2001 (28.09.2001) JP

(84) Designated States (*regional*): European patent (AT, BE,
CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC,
NL, PT, SE, TR).

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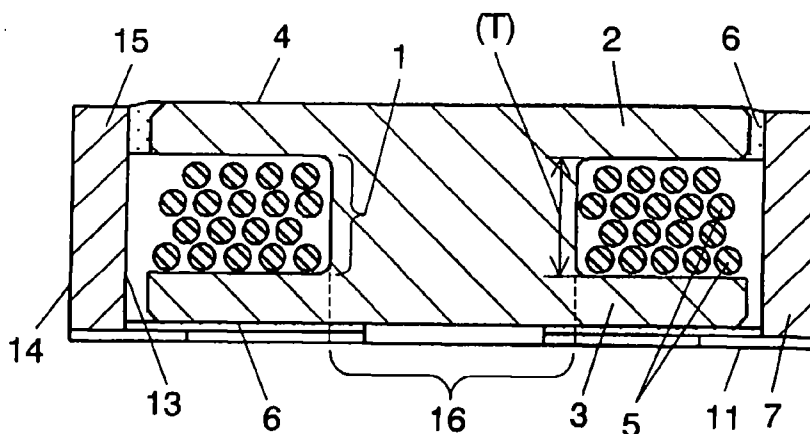
Published:
— with international search report

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*For two-letter codes and other abbreviations, refer to the "Guid-
ance Notes on Codes and Abbreviations" appearing at the begin-
ning of each regular issue of the PCT Gazette.*

(54) Title: INDUCTANCE DEVICE



(57) Abstract: An inductance device includes terminals (9) which are mounted to the inductance device from outside of a ring core (7). A fit-section (12) of one of each terminal (9) is bent along an outer wall (14), an upper face (15) of a groove (19), and an inner wall (13) of the ring core (7). A mount-section (11) of one of each terminal (9) extends from vicinity of an outer perimeter of the ring core (7) toward inside of a drum core (4) along a lower brim (3). When a shock is applied to the drum core (4) or the ring core (7), this structure prevents the drum core (4) and the ring core (7) from falling away from a board, where they have been mounted, leaving vicinity of the fit-section (12) of the terminal (9) on the board. This structure thus improves shock-proofness of the inductance device.

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